



No.4871

2SK2171

N-Channel Junction Silicon FET

High-Frequency, Low-Frequency Amp  
Analog Switch Applications**Features**

- Adoption of FBET process.
- Large  $|Y_{fs}|$ .
- Small Ciss.
- High  $P_D$  allowable power dissipation.

**Absolute Maximum Ratings at Ta=25°C**

			unit
Drain-to-Source Voltage	$V_{DSX}$	40	V
Gate-to-Drain Voltage	$V_{GDS}$	-40	V
Gate Current	$I_G$	10	mA
Drain Current	$I_D$	100	mA
Allowable Power Dissipation	$P_D$	400	mW
		800	mW
Junction Temperature	$T_j$	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

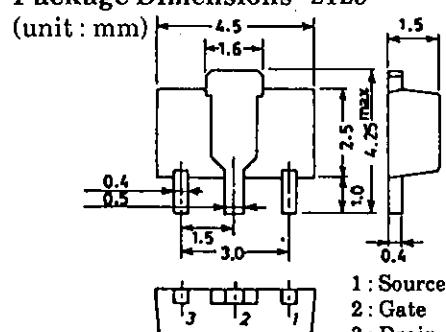
**Electrical Characteristics at Ta=25°C**

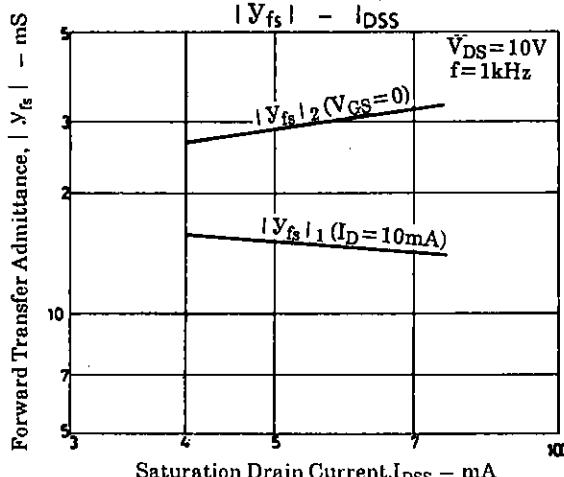
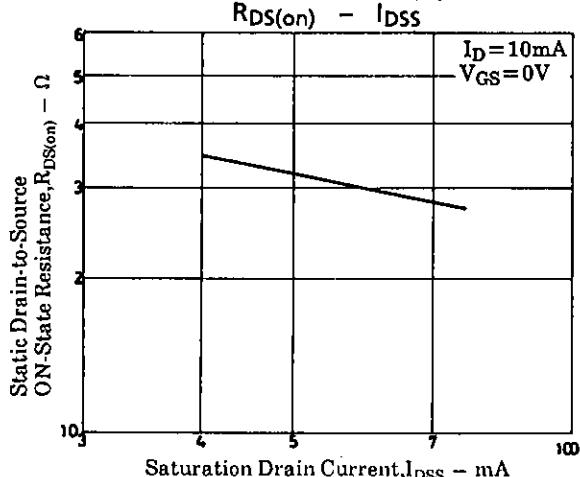
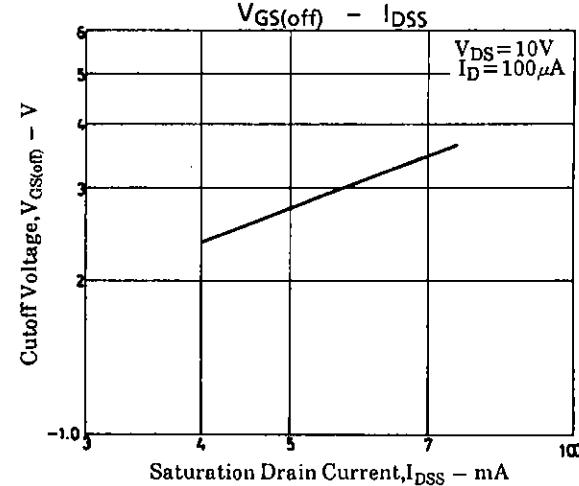
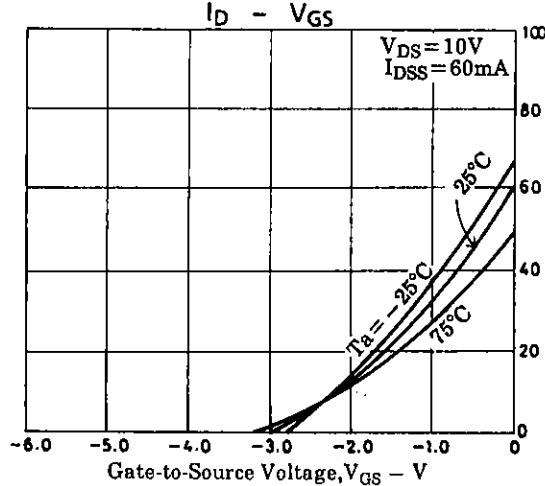
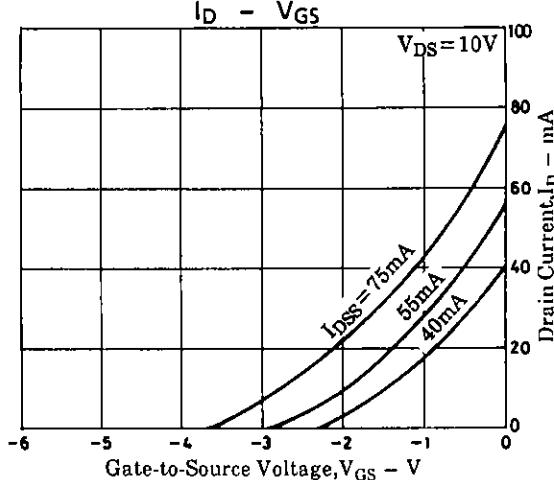
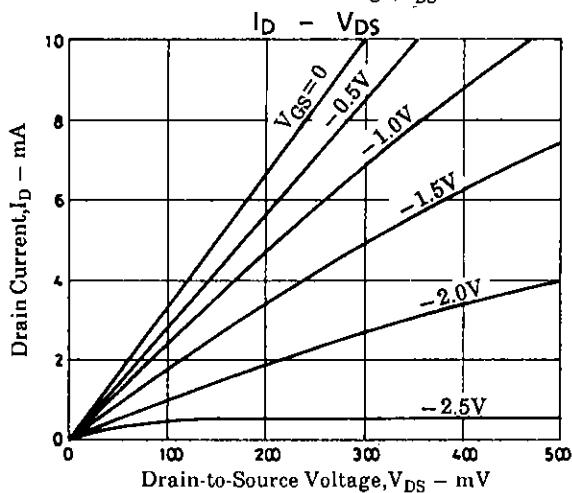
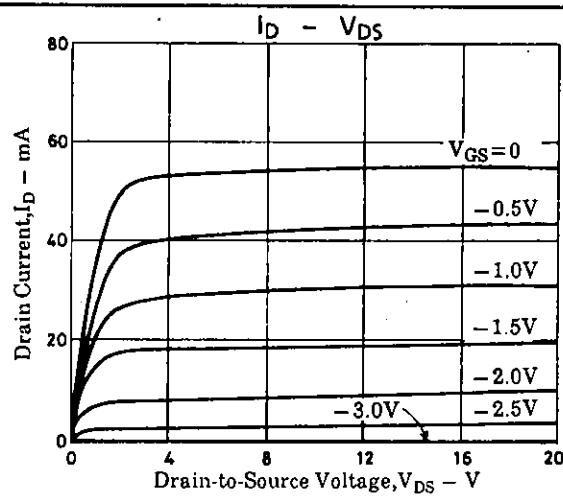
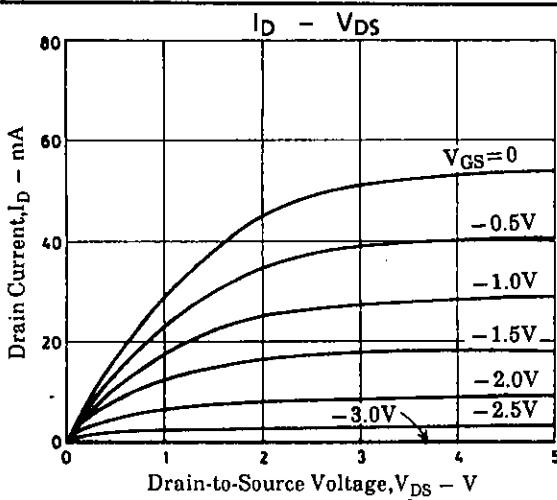
			min	typ	max	unit
G-D Breakdown Voltage	$V_{(BR)GDS}$	$I_G = -10\mu A, V_{DS} = 0$	-40			V
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{GS} = -20V, V_{DS} = 0$			-1.0	nA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 10V, I_D = 100\mu A$	-2.0	-3.0	-5.0	V
Drain Current	$I_{DSS}^*$	$V_{DS} = 10V, V_{GS} = 0$	40*		75*	mA
Forward Transfer Admittance	$ Y_{fs} $ (1)	$V_{DS} = 10V, I_D = 10mA, f = 1kHz$	10	15		mS
	$ Y_{fs} $ (2)	$V_{DS} = 10V, V_{GS} = 0, f = 1kHz$	22	30		mS
Input Capacitance	$C_{iss}$	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		11		pF
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		2.5		pF
Noise Figure	NF	$V_{DS} = 10V, R_g = 1k\Omega, I_D = 1mA, f = 1kHz$		1.5		dB
Static Drain-to-Source ON-State Resistance	$R_{DS(on)}$	$V_{DS} = 10mV, V_{GS} = 0$		30		Ω

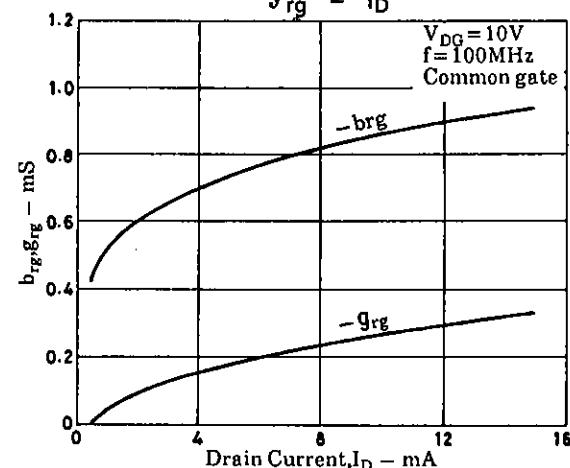
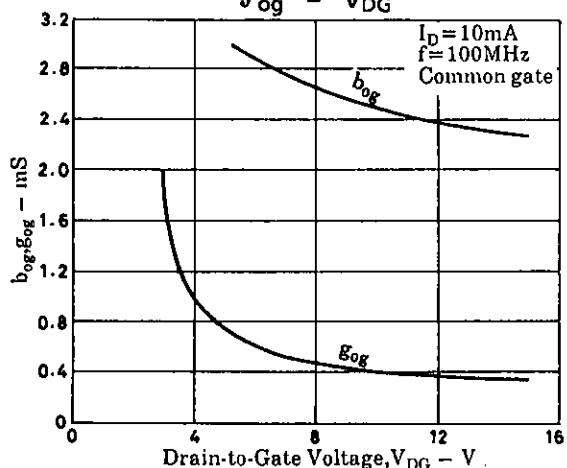
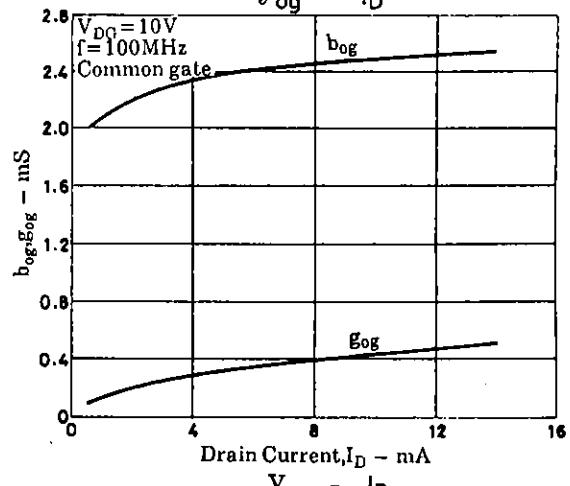
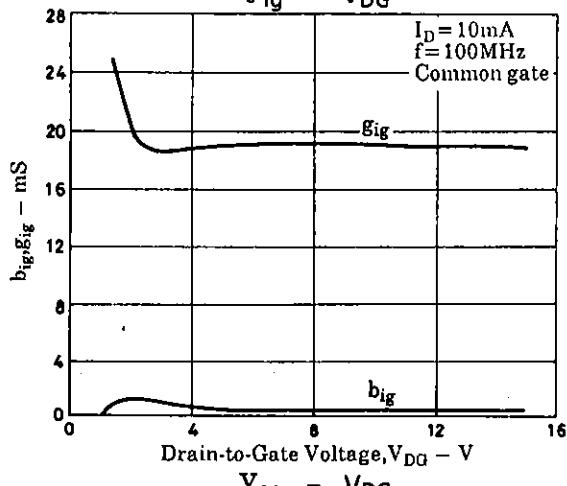
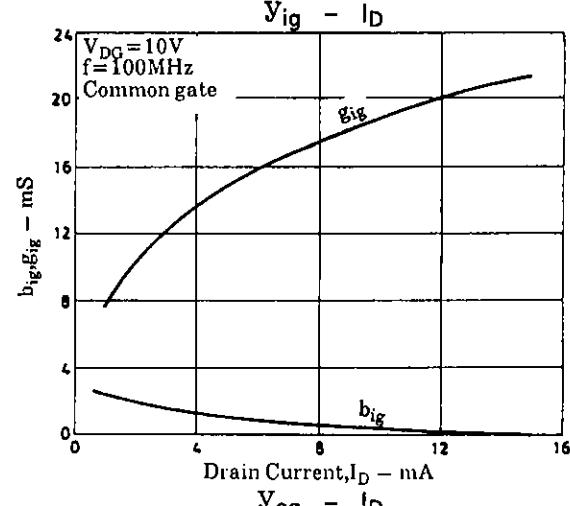
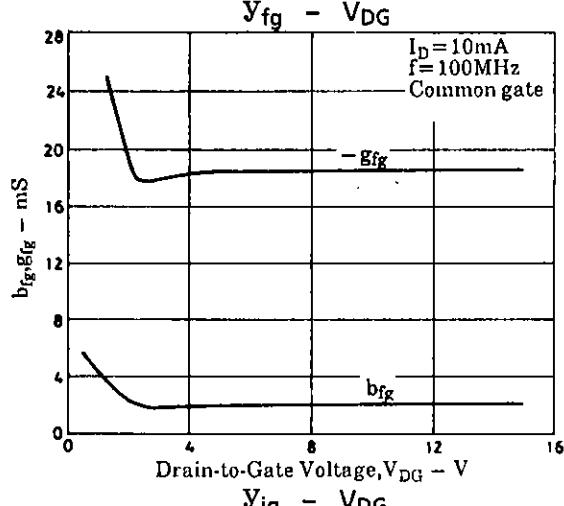
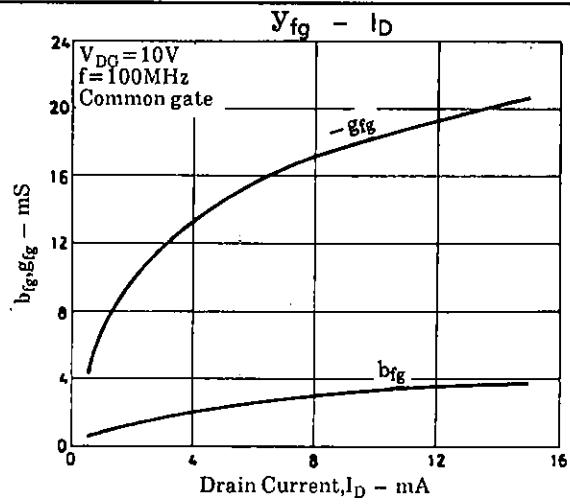
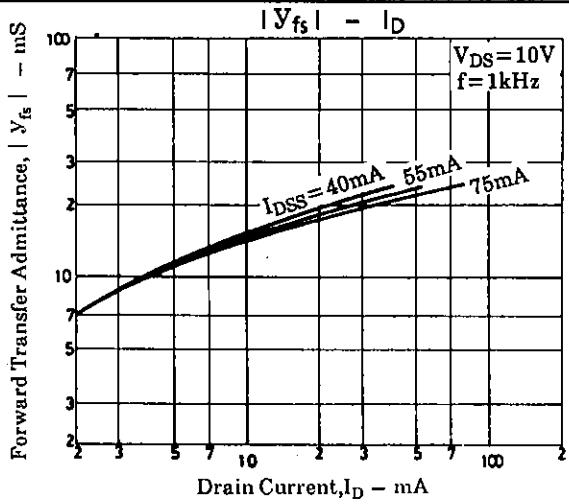
\*Pulse Test Pulse Width  $\leq 2mS$ ※ : The 2SK2171 is classified by  $I_{DSS}$  as follows : (unit : mA)

40 3 52	48 4 63	57 5 75
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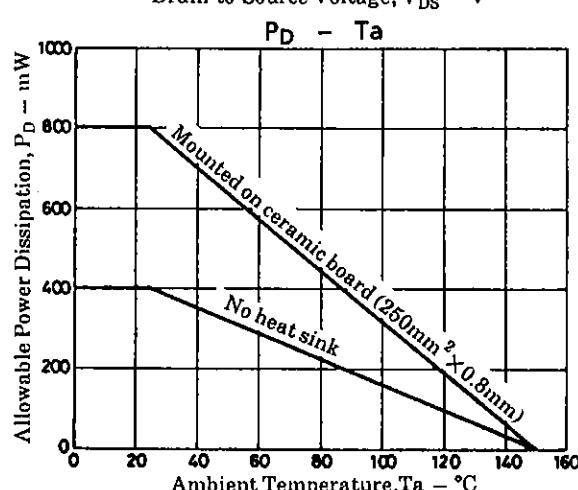
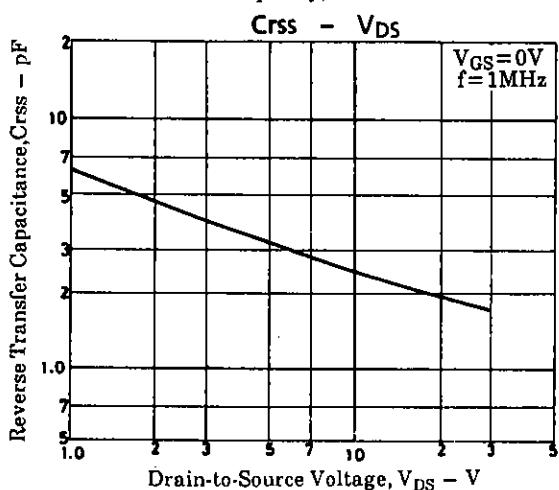
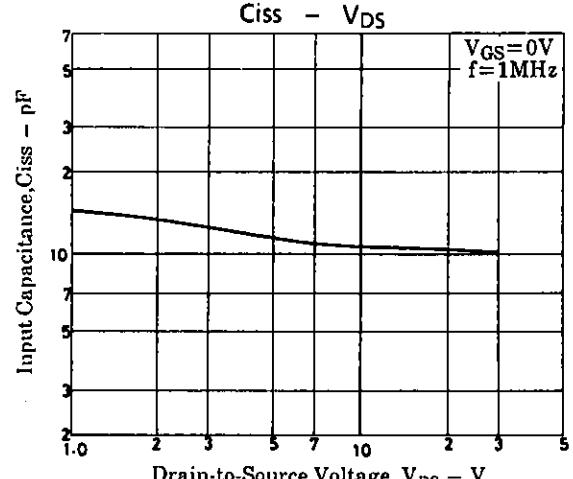
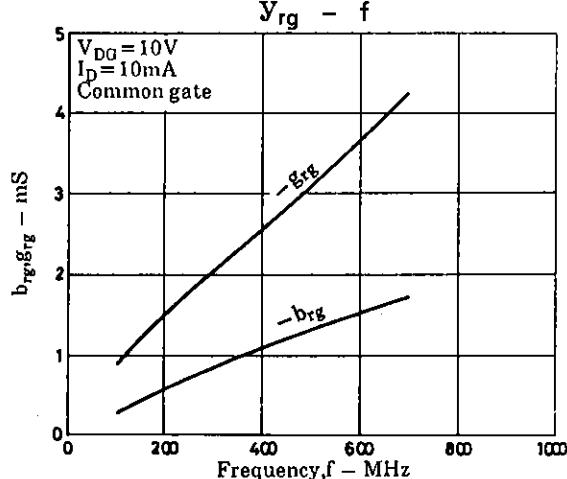
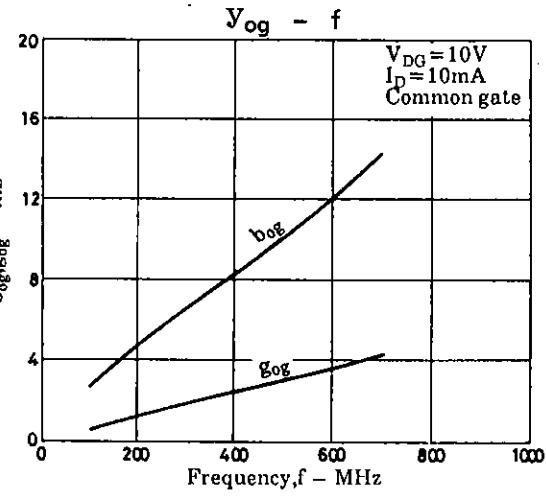
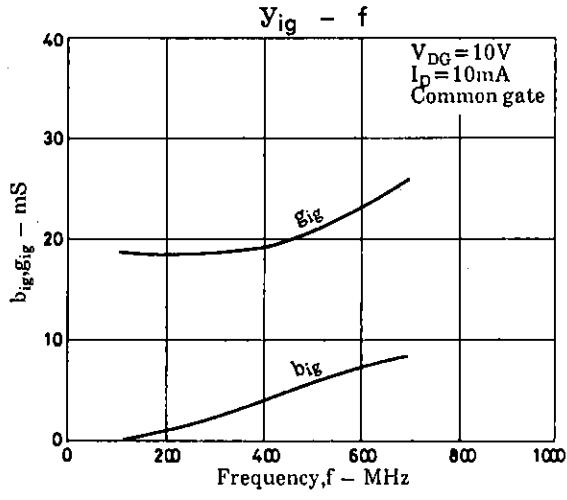
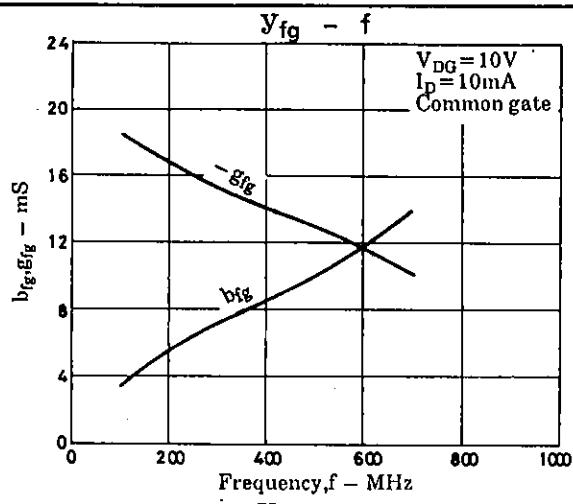
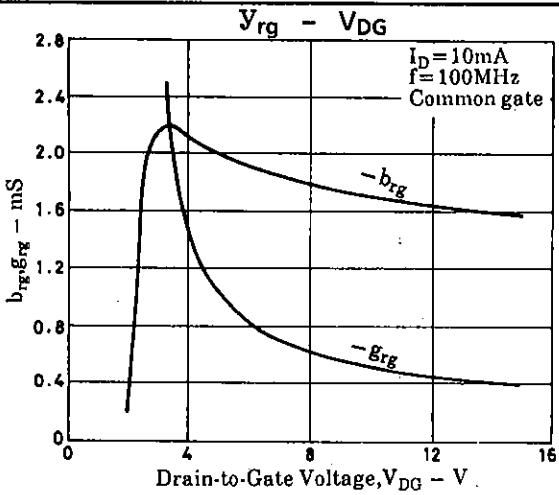
Marking : KM

 $I_{DSS}$  rank : 3, 4, 5**Package Dimensions 2125**SANYO : PCP  
(Bottom View)
**SANYO Electric Co., Ltd. Semiconductor Business Headquarters**  
TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110 JAPAN





# 2SK2171



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